



# Product Change Notification

**Change Notification #:** 115324 - 00  
**Change Title:** Intel® Dual Band Wireless-AC 3168 SKUs:  
3168.NGWG; 3168.NGWG.S  
PCN 115324-00, Label,  
Label Update  
**Date of Publication:** February 28, 2017

**Key Characteristics of the Change:**  
Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Mar 24, 2017
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## Description of Change to the Customer:

The Intel® Dual Band Wireless-AC 3168 SKUs listed in the products affected table below will undergo the following change:

Updating the manufacturing IDs from an old set of IDs to a new set of IDs.

There is no change to the sites only the coding on the label.

Manufacturer	Old Manufacturing ID	New Manufacturing ID
Gemtek	36214	ITG00
SPIL	10865	ITS00
Azureware	75331	ITA00
BCM1	10865	FLB00

## Customer Impact of Change and Recommended Action:

The label change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	TA
3168.NGWG	944884	J20109-002
3168.NGWG.S	944885	J20125-002

## **PCN Revision History:**

**Date of Revision:**

February 28, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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